

Upcoming: April 17–21 MRS Spring Meeting, MRS; May 15–18 ICNDST & ADC 2006 Joint Conf., MRS; and May 29–June 2 E-MRS-IUMRS-ICEM 06, IUMRS, E-MRS

To list an event in the Calendar, contact J. Meiksin, Materials Research Society, 506 Keystone Drive, Warrendale, PA 15086-7573; 724-779-3004 ext. 522; fax 724-779-8313; bulletin@mrs.org.

MRS, A-MRS, B-MRS, C-MRS, E-MRS, MRS-A, MRS-I, MRS-J, MRS-K, MRS-R, MRS-S, MRS-T, M-MRS, or IUMRS at the end of an entry indicates sponsorship or co-sponsorship of an event by the International Union of Materials Research Societies or one of its adhering bodies. "Endorsed" identifies events endorsed by MRS.

▼ identifies a new or revised entry this month.

See the January 2006 MRS BULLETIN for March 2006 Calendar entries. For updates, access www.mrs.org.

APRIL 2006

1–2 Northeast Bioengineering Conf., *Easton, PA*. Lafayette College, Ismail Jouny, Acopian Engineering Center, Easton, PA, 18042; 610-330-5414; fax 610-330-5059; e-mail jounyi@lafayette.edu; ww2.lafayette.edu/~nebc2006.

1–5 Experimental Biology 2006 Annual Meeting, *San Francisco, CA*. Jean Lash, FASEB/OSMC, 9650 Rockville Pike, Bethesda, MD, 20814; 301-634-7009; fax 301-634-7014; e-mail jlash@faseb.org; www.faseb.org/meetings/eb2006.

2–4 Small Fuel Cells for Portable Applications, *Washington, DC*. Knowledge Foundation, 18 Webster Street, Brookline, MA, 02446-4938; (617) 232-7400; fax (617) 232-9171; e-mail custserv@knowledgefoundation.com; www.knowledgefoundation.com.

3–5 Pacific Intl. Conf. on Applications of Lasers and Optics (PICALO 2006), *Melbourne, Australia*. Laser Institute of America, 13501 Ingenuity Drive, Suite 128, Orlando, FL 32826; 407-380-1553; fax 407-380-5588; e-mail bcohen@laserinstitute.org; www.laserinstitute.org/conferences/picalo.

3–7 SPIE—Photonics Europe 2006, *Strasbourg, France*. SPIE, P.O. Box 10, Bellingham, WA 98227-0010; 360-676-3290; fax 360-647-1445; e-mail spie@spie.org; spie.org/conferences/calls/06/epe.

4–6 World Copper Conf., *Santiago, Chile*. Marilyn Portner, CRU Events, 31 Mount Pleasant, London WC1X 0AD, United Kingdom, 44-20-7903-2402; e-mail cruevents@crugroup.com; www.cruevents.com.

5–7 Materials Congress 2006, *London, UK*. Lisa Bromley, IOM Communications, 1 Carlton House, London, SW1Y 5DB, UK; 44-20-7451-7302; fax 44-20-7839-2289; e-mail lisa.bromley@iom3.org; www.iom3.org/congress.

6–9 IEEE Intl. Symp. on Biomedical Imaging: From Nano to Macro, *Arlington, VA*. Jelena Kovacevic, Carnegie Mellon University, Dept. of Biomedical Engineering, 5000 Forbes Avenue, Pittsburgh, PA 15213; e-mail jelenak@cmu.edu; www.biomedicalimaging.org.

9–12 ▼ Focus on Microscopy, *Perth, Australia*. David Sampson, University of Western Australia, School of Electrical, Electronic, & Computer Engineering, Optical Engineering Laboratory, M018, 35 Stirling Highway, Crawley, WA 6009, Australia, 6-6488-2317; fax 8-6488-1319; e-mail dsampson@ee.uwa.edu.au; www.focusonmicroscopy.org.

9–14 Frontiers in Boundary Lubricating Films, *Lyon, France*. ECI, 6 Metro Tech Center, Brooklyn, NY, 11201; 718-260-3743; fax 718-260-3754; e-mail info@eci.poly.edu; www.engconfintl.org/6al.html.

10–13 Intl. Conf. on Deformation, Yield and Fracture of Polymers (DYFP2006), *Rolduc Abbey, Netherlands*. Marleen Rieken, Eindhoven University of Technology, P.O. Box 513, NL-5600 MB Eindhoven, Netherlands, 31-40-2472851; fax 31-40-2447355; e-mail DYFP2006@tue.nl; www.dyfp2006.tue.nl.

17–20 Intl. Society of Electrochemistry (ISE) Spring Meeting 2006, *Singapore*. Secretariat ISE Spring 2006 Conference, 1122A Serangoon Road, Singapore, 65-6295-5790; fax 65-6295-5790; e-mail secretariat@ise2006.org; www.ise2006.org.

17–21 2006 MRS Spring Meeting, *San Francisco, CA*. Materials Research Society, 506 Keystone Drive, Warrendale; 724-779-3003; fax 724-779-8313; e-mail info@mrs.org; www.mrs.org. **MRS.**

19–21 ▼ Dalton Discussion 9: Functional Molecular Assemblies, *Manchester, UK*. RSC Conferences, Thomas Graham House, Science Park, Milton Road, Cambridge CB4 0WF, UK, 44-0-1223-432254; fax 44-0-1223-423623; www.rsc.org/ConferencesAndEvents/RSCConferences/DD9.

22–25 ▼ APS April Meeting 2006, *Dallas, TX*. APS, www.aps.org/meet/calendar.cfm.

22–27 49th SVC Annual Technical Conf., *Washington, D.C.* Society of Vacuum Coaters; 505-856-7188; e-mail svcinfo@svc.org; www.svc.org.

23–27 AICHe 2006 Spring National Meeting, *Orlando, FL*. American Institute of Chemical Engineers, 3 Park Avenue, New York, NY 10016-5991; 212-591-7338; fax 212-591-8894; e-mail meetmail@aiche.org; aiche.confex.com/aiche/s06/cfp.epl.

23–27 World Congress on Particle Technology (WCPT5), *Lake Buena Vista, FL*. George Klinzing, University of Pittsburgh, Office of the Provost, 826 Cathedral of Learning, Pittsburgh, PA 15260; 412-624-0784; fax 412-624-4618; e-mail confchair@wcpt5.org; www.erpt.org/wcpt5.

23–28 Intl. Conf. on Mechanics and Mechanical Properties of Non-crystalline Materials I: Amorphous Metals, *Beijing, China*. ECI, 6 Metro Tech Center, Brooklyn, NY, 11201; 718-260-3743; fax 718-260-3754; e-mail info@eci.poly.edu; www.engconfintl.org/6am.html.

24–26 Intl. Brazing and Soldering Conf. (IBSC) *San Antonio, TX*. ASM International Customer Service, 9639 Kinsman Road, Materials Park, OH 44073-0002; 800-336-5152 ext. 6; fax 440-338-4634; customer.service@asminternational.org; www.asminternational.org/ibsc.

24–26 ▼ Intl. Technical Conf. on Diamond, CBN, and their Applications (INTERTECH 2006), *Atlanta, GA*. Industrial Diamond Association of America, P.O. Box 29460, Columbus, OH, 43229; 614-797-2265; fax 614-797-2264; e-mail tkane-ida@insight.rr.com; www.intertechconference.com.

24–28 Integrated Photonics Research and Applications Topical Meeting (IPRA) and Nanophotonics Topical Meeting (NP), *Uncasville, CT*. Optical Society of America, 2010 Massachusetts Ave., NW, Washington, DC 202-223-8130; fax 202-223-1096; e-mail info@osa.org; www.osa.org/meetings/topicals/ipr_np.

25–26 Joining Plastics 2006, *London, United Kingdom*. Rapra Technology, Shawbury, Shrewsbury, SY4 4NR, United Kingdom, 44-0-1939-250383; fax 44-0-1939-251118; e-mail conferences@rapra.net; www.rapra.net/conferences/JoiningPlastics06.

25–27 IMAPS/ACerS Intl. Conf. and Exhibition on Ceramic Interconnect and Ceramic Microsystems Technologies (CICMT), *Denver, CO*. The American Ceramic Society, 735 Ceramic Place, Suite 100, Westerville, OH 43081; 614-890-4700; fax 614-899-6109; e-mail info@ceramics.org; www.cicmt.org.

26–28 TAPPI 2006 Intl. Conf. on Nanotechnology for the Forest Products Industry, *Atlanta, GA*. www.tappi.org/06NANO.

26–29 SFB 2006—Society for Biomaterials Annual Meeting and Exposition, *Pittsburgh, PA*. Rebecca Hanes, Society for Biomaterials, 17000 Commerce Parkway, Suite, Mt. Laurel, 856-439-0826 x3061; fax 856-439-0525; e-mail rhaines@ahint.com; www.biomaterials.org/Meetings/06AnnualMeeting.

30–5 ▼ Gordon Research Conf. on Photosensory Receptors and Signal Transduction, *Barga, Italy*. Roberto Bogomolni, University of California, Santa Cruz, Dept. of Chemistry & Biochemistry, 289 Thimann Lab, 1156 High Street, Santa Cruz, CA, 95064; e-mail bogo@chemistry.ucsc.edu; www.grc.org/programs/2006/photosen.htm.

MAY 2006

1–5 ▼ Intl. Conf. on Metallurgical Coatings and Thin Films (ICMCTF 2006), *San Diego, CA*. Mary Gray, ICMCTF-2003, Suite 136, 14001-C St. Germain Drive, Centreville, VA, 20121; 703-266-3287; fax 703-968-8877; e-mail icmctf@mindspring.com; www2.avs.org/conferences/icmctf.

1–5 ▼ Intl. Conf. on Quantum Dots (QD2006), *Chamonix-Mont Blanc, France*. K. Kheng, e-mail info.qd2006@ujf-grenoble.fr; www-lsp.ujf-grenoble.fr/qd2006.

3–6 Intl. Conf. on High Performance Structures and Materials, *Ostend, Belgium*. Wessex Institute of Technology Conferences, Ashurst Lodge, Ashurst, Southampton, SO40 7AA, UK; 44-0-238-029-3223; fax 44-0-238-029-2853; e-mail enquiries@wessex.ac.uk; www.wessex.ac.uk/conferences/2006/hpsm06.

7–11 Intl. Conf. on Shape Memory and Superelastic Technologies (SMST), *Pacific Grove, CA*. ASM International Customer Service, 9639 Kinsman Road, Materials Park, OH 44073-0002; 800-336-5152 ext. 6; fax 440-338-4634; customer.service@asminternational.org; www.asminternational.org/shape.

7–11 Nanotech 2006/Bio Nano 2006, *Boston, MA*. Sarah Wenning, 696 San Ramon Valley Blvd., Ste. 423, Danville, 925-901-4959; fax 925-886-8461; e-mail wenning@nsti.org; www.nsti.org/Nanotech2006.

7–11 SPE—Annual Technical Conference (ANTEC), *Charlotte, NC*. Society of Plastics Engineers, SPE—Europe, Belgium; 32-0-3-541-77-55; fax 32-0-3-541-84-25; e-mail spe.europe@pi.be; www.speurope.org.

7–12 ▼ Electrochemical Society Meeting, *Denver, CO*. Electrochemical Society, 65 South Main Street, Building D, Pennington, NJ, 08534-2839; 609-737-1902; fax 609-737-2743; e-mail ecs@electrochem.org; www.electrochem.org/meetings/future/209/meeting.htm.

7–12 Intl. Symp. on Dielectrics for Nanosystems: Materials Science, Processing, Reliability, and Manufacturing II, *Denver, CO*. Durgamadhhab Misra, New Jersey Institute of Tech., 161 Warren St., Newark, 973-596-5739; fax 973-596-5680; e-mail dmsira@njit.edu; www.electrochem.org/meetings/future/209/meeting.htm.

7–12 World Conf. on Photovoltaic Energy Conversion, *Waikoloa, HI*. Sheila Bailey, NASA Glenn Research Center, Cleveland, 216-433-2228; fax 216-433-6106; e-mail sheila.g.bailey@nasa.gov; www.meetingassistant.com/PVSC/worldconference.php.

8–10 Intl. Conf. on Advances in Fluid Mechanics, *Skithos, Greece*. Wessex Institute of Technology Conferences, Ashurst Lodge, Ashurst, Southampton, SO40 7AA, UK; 44-0-238-029-3223; fax 44-0-238-029-2853; e-mail enquiries@wessex.ac.uk; www.wessex.ac.uk/conferences/2006/afm06.

8–11 IEEE Intl. Conf. on Indium Phosphide and Related Materials (IPRM), *Princeton, NJ*. IEEE/LEOS, 445 Hoes Lane, PO Box 1331, Piscataway, NJ, 08855; 732-562-3899; fax 732-562-8434; e-mail leosconferences@ieee.org; www.i-leos.org.

10–12 ▼ World Conf. on Boundary Elements and Other Mesh Reduction Methods, *Skithos, Greece*. Wessex Institute of Technology Conferences, Ashurst Lodge, Ashurst, Southampton, SO40 7AA, UK, 44-0-238-029-3223; fax 44-0-238-029-2853; e-mail enquiries@wessex.ac.uk; www.wessex.ac.uk/conferences/2006/bem28.

10–12 ▼ World Congress on Biosensors (BIOSENSORS 2006), Toronto, ON. Janet Seabrook, Elsevier, The Boulevard, Langford Lane, Kidlington, Oxford, OX5 1GB, UK, +44 (0)1865 843691; fax +44 (0)1865 853282; e-mail jm.seabrook@elsevier.com; www.biosensors-congress.elsevier.com.

12–16 ▼ American Association of Immunologists (AAI) Annual Meeting, Boston, MA. Jean Lash, FASEB/OSMC, 9650 Rockville Pike, Bethesda, MD, 20814; 301-634-7009; fax 301-634-7014; e-mail jlash@faseb.org; www.faseb.org/meetings.

13–16 Particles 2006—Medical/Biochemical Diagnostic, Pharmaceutical, and Drug Delivery Applications of Particle Technology, Orlando, FL. Particles 2006, 265 Clover Street, Rochester, NY 14610-2246; 585-288-5913; fax 585-482-7795; e-mail info@nanoparticles.org; nanoparticles.org/Particles2006.

14–17 Intl. Pharmaceutical Industry Conf., Edinburgh, United Kingdom. Laura Milne, SCI 14/15 Belgrave Square, London, United Kingdom, 44-0-20-7598-1565; fax 44-0-20-7235-7743; e-mail laura.milne@soci.org; www.soci.org/SCI/SClpharm/html/home.jsp.

14–19 Intl. Fatigue Congress (Fatigue 2006), Atlanta, GA. Nina Woods, Elsevier, The Boulevard, Langford Lane, Kidlington, Oxford, United Kingdom, 44-0-1865-843297; fax 44-0-1865-843958; e-mail n.woods@elsevier.com; www.fatigue2006.com.

15–17 Intl. Surface Engineering Congress, Seattle, WA. ASM International Customer Service, 9639 Kinsman Road, Materials Park, OH 44073-0002; 800-336-5152 ext. 6; fax 440-338-4634; customer.service@asminternational.org.

15–17 Intl. Thermal Spray Conf. and Exposition, Seattle, WA. International ASM, 9639 Kinsman Rd., Materials Park, OH 44073-0002; 800-336-5152 ext. 6; fax 440-338-4634; e-mail Cust-srv@asminternational.org; www.asminternational.org/itsc.

15–18 AeroMat Conf. & Exposition, Seattle, WA. ASM International Customer Service, 9639 Kinsman Road, Materials Park, OH 44073-0002; 800-336-5152 ext. 6; fax 440-338-4634; customer.service@asminternational.org.

15–18 ICNDST & ADC 2006 Joint Conf., Research Triangle Park, NC. Materials Research Society, 506 Keystone Drive, Warrendale, PA 15086; 724-779-3003; fax 724-779-8313; e-mail info@mrs.org; www.mrs.org. **MRS**

15–19 ▼ Intl. Symp. on Blue Laser and Light Emitting Diodes (ISBLED), Montpellier, France. Thierry Bretagnon, University Montpellier II, GES-CC074, F-34095, Montpellier, Cedex, France, e-mail secretary@ges.univ-montp2.fr; www.isbled2006.org.

15–20 Intl. Symp. on Functional Pi-Electron Systems, Osaka, Japan. Kenichi Nakayama, Osaka University, 2-1 Yamadaoka, Suita, Osaka, Japan, e-mail nakayama@mls.eng.osaka-u.ac.jp; www.molsys.mls.eng.osaka-u.ac.jp/tpi7.

16–17 Blowing Agents and Foaming Processes 2006, Munich, Germany. Rapra Technology, Shawbury, Shrewsbury, SY4 4NR, United Kingdom, 44-0-1939-250383; fax 44-0-1939-251118; e-mail conferences@rapra.net; www.rapra.net/conferences/blowingagents06.

16–19 Glass and Optical Materials Meeting, Greenville, SC. American Ceramic Society, Suite 100, Westerville, OH, 43081; 614-890-4700; fax 614-899-6109; e-mail info@ceramics.org; ceramics.org/meetings/gomd06.

16–20 ▼ APS—Annual Division of Atomic, Molecular and Optical Physics Meeting, Knoxville, TN. APS, jmacek@utk.edu; www.aps.org/meet/calendar.cfm.

17–19 Intl. Symp. Interface Biology of Implants, Rostock, Germany. Joachim Rychly, Universität Rostock, Ernst-Heydemann-Str. 6, 18057 Rostock, Rostock, Germany, 49-0-381-494-7773; fax 49-0-381-494-5730; e-mail joachim.rychly@med.uni-rostock.de; www.uni-rostock.de/ibi.

20–24 ▼ Intl. Society of Analytical Cytology (ISAC) Meeting, Quebec City, QC. Jean Lash, FASEB/OSMC, 9650 Rockville Pike, Bethesda, MD, 20814; 301-634-7009; fax 301-634-7014; e-mail jlash@faseb.org; www.faseb.org/meetings.

21–24 ▼ 2006 Biennial Polymer Innovation at Emerging Boundaries of Science and Engineering, Key Biscayne, FL. Lesia Linkous, Virginia Tech, 410 Davidson Hall, MC 0279, Blacksburg, VA, 24061; 540-231-3052; fax 540-231-2588; e-mail lesiar@vt.edu; www.polyacs.org/arcmeetings/biennial.506.shtml.

21–26 Conf. on Lasers and Electro-Optics - Quantum Electronics and Laser Science (CLEO/QELS), Long Beach, CA. Optical Society of America, 2010 Massachusetts Ave., NW, Washington, 202-223-8130; fax 202-223-1096; e-mail info@osa.org; www.cleoconference.org.

21–26 Polymer Reaction Engineering, Halifax, NS. ECI, 6 Metro Tech Center, Brooklyn, NY, 11201; 718-260-3743; fax 718-260-3754; e-mail info@eci.poly.edu; www.engconfintl.org/6ab.html.

22–25 Intl. Symp. on Colloidal and Molecular Electrooptics (ELOPTO-2006), Kyoto, Japan. Tsuneo Okubo, Yamagata University, Cooperative Research Center, Johnan 4-3-16 Yonezawa 992-8510 Japan; 81-238-26-3602; fax 81-238-26-3409; e-mail okubo@yz.yamagata-u.ac.jp; www.elopto.jp.

22–26 ICMOVPE XIII—Intl. Conf. on Metal-Organic Vapor Phase Epitaxy, Miyazaki, Japan. Yoshinao Kumagai, Tokyo University of A & T, Koganei, Tokyo 184-8588, Japan; 81-42-388-7469; fax 81-42-386-3003; e-mail icmovpe@cctuat.ac.jp; icmovpe13.chem.tuat.ac.jp

23–27 Seminar and Meeting on Ceramics, Cells and Tissues: Materials for Scaffolding of Biologically Engineered Systems, Faenza, Italy. Rossella Ravaglioli, ISTE-CNR, Via Granarolo, 64-48018, Faenza, Ravenna, Italy, 39-0546-670-311; fax 39-0546-670-399; e-mail 10cct@agenziapoloceramico.it; www.istec.cnr.it.

24–26 Intl. Conf. Comparing Design in Nature with Science and Engineering, The New Forest, UK. Wessex Institute of Technology Conferences, Ashurst Lodge, Ashurst, Southampton, SO40 7AA, UK; 44-0-238-029-3223; fax 44-0-238-029-2853; e-mail enquiries@wessex.ac.uk; www.wessex.ac.uk/conferences/2006/design06.

24–27 Intl. Conf. on Perspective Technologies and Methods in MEMS Design (MEMSTECH), Lviv, Ukraine. Mykola Pereyina, Lviv Polytechnic National University, St. Bandera 12, 79013, Lviv, Ukraine, 38-0322-72-29-72; fax 38-0322-72-29-72; e-mail memstech@polynet.lviv.ua; www.lp.edu.ua/Institute/IKN/CAD/MEMSTECH.

25–26 ▼ Baosteel Biennial Academic Conf. (BAC 2006), Shanghai, China. Secretariat Shanghai Baosteel Group Corporation, Room 401, Building O, Baosteel Technology Center, No. 889 Fujin Road, Baoshan District, Shanghai 201900, P.R. China, 86-21-26649887; fax 86-21-56781258; e-mail BAC2006@baosteel.com; BAC.baosteel.com.

26 IEEE/LEOS Semiconductor Laser Workshop, Long Beach, CA. IEEE/LEOS, 445 Hoes Lane, PO Box 1331, Piscataway, NJ, 08855; 732-562-3899; fax 732-562-8434; e-mail leosconferences@ieee.org; www.i-leos.org.

28–1 Intl. Symp. on Macro- and Supramolecular Architectures and Materials (MAM-06); Practical Nano-Chemistry and Novel Approaches, Tokyo, Japan. Waseda University, Symposium MAM-06, Tokyo, Japan, 81-3-3200-2669; fax 81-3-3209-5522; e-mail MAM-06@mse.waseda.ac.jp; www.waseda.jp/assoc-MAM-06.

28–2 MCWASP—Modeling of Casting, Welding and Advanced Solidification Processes Conference, Opio, France. ESA Conference Bureau/Congrex Holland BV, MCWASP, P.O. Box 299, AG Noordwijk, Netherlands; 31-71-565-5005; fax 31-71-565-5658; e-mail Esa.Conference.Bureau@esa.int; www.mcwasp.org.

29–2 E-MRS—IUMRS—ICEM 06, Nice, France. P. Siffert, E-MRS 2006 Spring Meeting, BP 20, 67037 Strasbourg Cedex 2, France; 33-3-88-10-65-43; fax 33-3-88-10-63-43; e-mail emrs@phase.c-strasbourg.fr; www-emrs.c-strasbourg.fr/2006_SPRING/2006_meeting.htm. **IUMRS; E-MRS.**

29–2 Structure and Mechanical Properties of Nanostructured Materials, Beijing, P.R. China. ECI, 6 Metro Tech Center, Brooklyn, NY 11201; 718-260-3743; fax 718-260-3754; e-mail info@eci.poly.edu; www.engconfintl.org/6au.html.

JUNE 2006

3–8 IEEE Intl. Conf. on Plasma Sciences (ICOPS), Acme, MI. Claire Rosser, Michigan State University, Rm. B100 RCE, East Lansing, MI, 48824; 517-432-8711; fax 517-432-8714; e-mail mcrosser@egr.msu.edu; www.icops2006.org.

4–9 Intl. Conf. on Modern Materials Science and Technology (CIMTEC), Acireale, Italy. Corso Mazzini, CIMTEC, 52—P.O. Box 174 48018, Faenza, Italy; 546-22461; fax 39-546-664138 e-mail congress@technagroup.it; www.cimtec-congress.org.

5–8 2nd Intl. FIB Congress 2006 (Intl. Federation for Structural Concrete), Naples, Italy. Secretariat FIB Congress, University of Naples Federico II, via Claudio, 21 - 80125, Naples, Italy, e-mail fib2006@unina.it; www.naples2006.com.

6–7 Medical Polymers 2006, Cologne, Germany. Rapra Technology, Shawbury, Shrewsbury, SY4 4NR, UK, 44-0-1939-250383; fax 44-0-1939-251118; e-mail conferences@rapra.net; www.rapra.net/conferences/medicalpolymers06.

6–8 Magneto-Optical Recording Intl. Symp. 2006 (MORIS 2006) Workshop, Chiba Prefecture, Japan. MORIS 2006 Workshop Secretariat, Proactive Inc., Promena Kobe 16F, 1-8-1, Higashikawasaki-cho, Chuo-ku, Kobe 650-0044, Japan; 81-78-366-5050; fax 81-78-366-5051; moris2006ws@pac.ne.jp; www.ecs.cst.nihon-u.ac.jp/moris2006ws. **Endorsed.**

7–9 ▼ Intl. Conf. on Monitoring, Simulation, Prevention and Remediation of Dense and Debris Flows, Rhodes, Greece. Wessex Institute of Technology Conferences, Ashurst Lodge, Ashurst, Southampton, SO40 7AA, UK, 44-0-238-029-3223; fax 44-0-238-029-2853; e-mail enquiries@wessex.ac.uk; www.wessex.ac.uk/conferences/2006/debris06.

8–10 IEEE Intl. Symp. on Technology and Society (ISTAS), Queens, NY. Clinton Andrews, Rutgers University, 33 Livingston Ave. #302, New Brunswick, NJ, 08901; 732-932-3822 ext721; fax 732-932-2253; e-mail c.j.andrews@ieee.org; www.ieeesit.org.

11–15 Advanced Membrane Technology III: Membrane Engineering for Process Intensification, Cetraro, Italy. ECI, 6 Metro Tech Center, Brooklyn, NY 11201; 718-260-3743; fax 718-260-3754; e-mail info@eci.poly.edu; www.engconfintl.org/gaj.html.

11–15 Intl. Conf. on Transport Phenomena in Micro and Nanodevices, Barga, Italy. ECI, 6 Metro Tech Center, Brooklyn, NY 11201; 718-260-3743; fax 718-260-3754; e-mail info@eci.poly.edu; www.engconfintl.org/6at.html.

11–16 ▼ Gordon Research Conf. on Ligand Recognition and Molecular Gating, Barga, Italy. Benjamin Kaupp, Research Centre Juelich, IBI-1, Juelich 52428, Germany, e-mail a.eckert@fz-juelich.de; www.grc.org/programs/2006/ligand.htm.

11–16 ▼ Gordon Research Conf. on Multiphoton Processes, Tilton, NH. Robert Jones, University of Virginia, 382 McCormick Road, PO Box 400714, Charlottesville, VA, 22904-4714; e-mail rrj3c@virginia.edu; www.grc.org/programs/2006/multipho.htm.

12–14 Intl. Conf. Advances in Fusion and Processing of Glass, Dresden, Germany. German Society of Glass Technology (DGG), Siemensstrabe 45, 63071 Offenbach, Germany; 49-0-69-975861-0; fax 49-0-69-975861-99; e-mail dgg@hvg-dgg.de; www.hvg-dgg.de/de/8th_international_conference.htm.

12-14 ▼ Printing of Functional Materials: Fundamental Chemistry and Materials Science, *Manchester, UK*. RSC Conferences, Thomas Graham House, Science Park, Milton Road, Cambridge CB4 0WF, UK, 44-0-1223-432254; fax 44-0-1223-423623; www.rsc.org/ConferencesAndEvents/RSCConferences/PFM.

12-15 Microwave Materials and their Applications, *Oulu, Finland*. MMA 2006, Microelectronics and Materials Physics Laboratories, Dept. of Electrical Engineering, University of Oulu, Linnanmaa, FIN-90570 Oulu, Finland; mma2006@ee.oulu.fi; www.ee.oulu.fi/research/miklab/mma2006.

12-16 ▼ Great Lakes Photonics Symp. 2006, *Dayton, OH*. SPIE Meetings, P.O. Box 10, Bellingham, WA, 98227-0010; 360-676-3290; fax 360-647-1445; e-mail spie@spie.org; spie.org/Conferences/calls/06/gl.

13-16 Northern Optics (NO2006), *Bergen, Norway*. Gerd Pettersen, Instituttvegen 25, PO Box 70, NO-2027 Kjeller, Norway, 47-6484-4703; fax 47-6381-8146; e-mail gerd@unik.no; web.unik.no/NO2006.

17-21 ▼ MPIF Intl. Conf. on Powder Metallurgy and Particulate Materials (PowderMet 2006), *San Diego, CA*. MPIF, 105 College Road East, Princeton, NJ, 08540; 609-452-7700; fax 609-987-8523; e-mail info@mpif.org; www.mpiif.org/Meetings.

18-21 ACS Colloid and Surface Science Symp., *Boulder, CO*. Daniel Schwartz, University of Colorado, Dept. of Chemical Engineering, Boulder, CO 80309-0424; 303-735-0240; fax 303-492-4341; e-mail daniel.schwartz@colorado.edu; www.colloid.org.

18-22 ▼ **Electroceramics X**, *Toledo, Spain*. Instituto de Cerámica y Vidrio, Sociedad Española de Cerámica y Vidrio, Kelsen 5, 28049 Cantoblanco, Madrid, Spain, 34-91-735-58-40; fax 34-91-735-58-43; e-mail electroceramics-x@icv.csic.es; www.estyloweb.com/electroceramics-x. **Endorsed.**

18-23 ▼ Gordon Research Conf. on Basement Membranes, *Barga, Italy*. Reinhard Faessler, Max Planck Institute for Biochemistry, Dept. Molecular Medicine, Am Klopferspitze 18A, Martinsried D-82152, Germany, e-mail faessler@biochem.mpg.de; www.grc.org/programs/2006/basement.htm.

18-23 ▼ Gordon Research Conf. on Tribology, *Waterville, ME*. Tom Dickinson, Washington State University, Department of Physics, Pullman, WA, 99164-2814; e-mail jtd@wsu.edu; www.grc.org/programs/2006/tribo.htm.

19-23 ▼ Cell-Materials Interactions: Regenerative Medicine, *Porto, Portugal*. Secretariat Cell-Material Interactions, Universidade do Porto, Biomaterials Laboratory, Rua do Campo Alegre, 823, 4150-180, Porto, Portugal, 35-1-22-6074982; fax 35-1-22-6094567; e-mail info@ineb.up.pt; http://www.ineb.up.pt.

21-25 ASME 2006 Summer Bioengineering Conf., *Amelia Island, FL*. Barry Lieber, University of Miami, Biomedical Engineering, Rm 203 McArthur Annex, 1251 Memorial Drive, Coral Gables, FL 33146; e-mail blieber@miami.edu; divisions.asme.org/bed/events/summer06.html.

24-30 **Beijing Intl. Materials Week**, *Beijing, China*. Lin Jianyun, Room 4102, 62 Zizhuyuan Road, Beijing, China, 86-10-68722031; fax 86-10-68722033; e-mail 2006BIMW@sohu.net; www.c-mrs.org.cn/ehuiyi_list.asp. **C-MRS.**

25-29 Intl. Congress on Ceramics, *Toronto, Canada*. American Chemical Society, 1155 Sixteenth Street NW, Washington, DC, 20036; 202-872-4374; fax 202-872-6128; e-mail natlmtgs@acs.org; www.ceramics.org.

25-30 ▼ Gordon Research Conf. on MEMS Technology and Biomedical Applications, *New London, CT*. Rafael Kleiman, McMaster University, Engineering Physics Dept., 1280 Main Street West, Hamilton, ON L8S 4L7, Canada; e-mail kleiman@mcmaster.ca; www.grc.org/programs/2006/mems.htm.

25-30 ▼ Gordon Research Conf. on Permeable Sediments, *Waterville, ME*. Carolyn Oldham, University of Western Australia, Center for Water Research, 35 Stirling Highway, Crawley, WA 6009, Australia, e-mail c.oldham@cw.r.uwa.edu.au; www.grc.org/programs/2006/permsed.htm.

25-30 ▼ Gordon Research Conf. on Three Dimensional Electron Microscopy, *Barga, Italy*. Helen Saibil, Birkbeck College, Crystallography Dept., Malet Street, London WC1E 7HX, UK; e-mail h.saibil@mail.cryst.bbk.ac.uk; www.grc.org/programs/2006/threed.htm.

25-30 Novel and Emerging Ceramics and Composites, *Kona Coast, HI*. ECI 6 Metro Tech Center, Brooklyn, NY 11201; 718-260-3743, fax 718-260-3754; e-mail info@eci.com; www.engconfintl.org/6afbody.html.

26-28 IASTED Intl. Conf. on Applied Simulation and Modelling, *Rhodes, Greece*. Secretariat IASTED, #80, 4500 16th Ave. N.W., Calgary, AB, T3B 0M6; 403-288-1195; fax 403-247-6851; e-mail calgary@iasted.org; www.iasted.org/conferences/2006/Greece/c522.htm.

26-29 ECM VII: Cartilage & Joint Repair, *Davos, Switzerland*. Sonia Wahl, AO Research Institute, Clavadelerstrasse, CH-7270 Davos Platz, Davos, Switzerland, 41-81-41-42-541; fax 41-81-41-42-299; e-mail sonia.wahl@aofoundation.org; www.ecmjournal.org/ecm_meetings/ecm7.

26-29 Intl. Energy Conversion Engineering Conf. (IECEC 2006), *San Diego, CA*. Michael Piszczor, NASA Glenn Research Center, Cleveland, OH, 44135; 216-433-2237; e-mail michael.piszczor@grc.nasa.gov; www.aiaa.org/events/iecec.

26-30 IEEE Intl. Conf. on Properties and Applications of Dielectric Materials (ICPADM), *Bali, Indonesia*. Dr. Suwarno, Bandung Institute of Technology, Jl. Ganesha 10, Bandung, Indonesia, 62-22-250-2260; fax 62-22-253-4222; e-mail suwarno@iee.org; www.icpdm2006.com.

26-30 ▼ National Space and Missile Materials Symp., *Orlando, FL*. Dan Cleyrat, National Space & Missile Materials Symposium, C/O: Anteon Corporation, 5100 Springfield Pike, Suite 509, Dayton, OH 45431, 937-656-6482; fax 937-254-2153; e-mail daniel.cleyrat@wpafb.af.mil; www.usasymposium.com/nsms.

28-29 ▼ TMS Electronic Materials Conf. (EMC), *University Park, PA*. TMS Meetings Services, 184 Thorn Hill Road, Warrendale, PA, 15086; 724-776-9000 x243; fax 724-776-3770; e-mail mtgserv@tms.org; www.tms.org/EMC.html.

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2-6 European Conf. on Foams, Emulsions and Applications (EUFOAM 2006), *Potsdam, Germany*. Reinhard Müller, Max Planck Institut Colloids and Interfaces, Am Muelenberg 1, D-14476 Potsdam-Golm, Germany; 49-331-567-9252; fax 49-331-567-9202; e-mail eufoam2006@mpikg.mpg.de; www.mpiikg.mpg.de/en/gf/foam2006.

2-6 ▼ Gordon Research Conf. on Defects In Semiconductors, *New London, NH*. Wladek Walukiewicz, Lawrence Berkeley National Laboratory, 1 Cyclotron Road, MS 2-200, Berkeley, CA, 94720; e-mail w_walukiewicz@lbl.gov; www.grc.org/programs/2006/defects.htm.

2-7 21st International Liquid Crystal Conference, *Keystone, CO*. Kinsley & Associates, Conference Management Office, LLC, 303-798-3664; ilcc@kinsleyassociates.com; www.ilcc2006.com.

2-7 ▼ Gordon Research Conf. on Vibrational Spectroscopy, *Biddeford, ME*. F. Fleming Crim, University of Wisconsin, Department of Chemistry, 1101 University Ave., Madison, WI, 53706; e-mail fcgrim@chem.wisc.edu; www.grc.org/programs/2006/vibrat.htm.

3-7 ▼ European Conf. of Fracture, *Alexandroupolis, Greece*. Emmanuel Gdoutos, Democritus University of Thrace, School of Engineering, GR-671 00, Xanthi, Greece, 30-25410-79651; fax 30-25410-79652; e-mail egdoutos@civil.duth.gr; ecf16.civil.duth.gr.

4-8 ▼ Intl. Conf. on Processing and Manufacturing of Advanced Materials, *Vancouver, Canada*. Tatiana Joksimovic, Services Suite 645, 375 Water Street, Vancouver, BC, V6B 5C6, Canada; 604-681-2503; fax 604-681-5226; e-mail thermec2006@venuewest.com; thermec.uow.edu.au.

5-7 ▼ Intl. Conf. on Advanced Computational Methods and Experimental Measurements in Heat and Mass Transfer, *The New Forest, UK*. Wessex Institute of Technology Conferences, Ashurst Lodge, Ashurst, Southampton SO40 7AA, UK, 44-0-238-029-3223; fax 44-0-238-029-2853; e-mail enquiries@wessex.ac.uk; www.wessex.ac.uk/conferences/2006/heat06.

5-7 ▼ Intl. Symp. on Organocatalysis in Organic Synthesis, *Glasgow, UK*. RSC Conferences, Thomas Graham House, Science Park, Milton Road, Cambridge CB4 0WF, UK, 44-0-1223-432254; fax 44-0-1223-423623; www.rsc.org/ConferencesAndEvents/RSCConferences/organocat06.

9-12 Fractography of Glasses and Ceramics V, *Rochester, NY*. The American Ceramic Society, 735 Ceramic Place, Suite 100, Westerville, OH 43081; 614-890-4700; fax 614-899-6109; e-mail info@ceramics.org; engineering.alfred.edu/outreach/conf/fractography.

9-12 Intl. Symp. on New Materials for Electrochemical Systems, *Montréal, Canada*. Secretariat New Materials 2006, Bureau des Congrès Universitaires, 6600 Côte-des-Neiges Road, Suite 510, Montreal, Quebec, H3S 2A9 Canada; 514-340-3215; fax 514-340-4440; e-mail newmat@congresbcu.com; newmaterials.congresbcu.com.

9-13 Structure and Dynamics of Self-Organized Macromolecular Systems, *Prague, Czech Republic*. Petr Štěpánek, Institute of Macromolecular Chemistry, Heyrovského nám. 2, CZ-162 06 Praha 6, Praha, Czech Republic, 420-296-809-332; fax 420-296-809-410; e-mail sympo@imc.cas.cz; www.imc.cas.cz/sympo/45micro.html.

10-12 ▼ Faraday Discussion 134: Atomic Transport and Defect Phenomena in Solids, *Guildford, UK*. RSC Conferences, Thomas Graham House, Science Park, Milton Road, Cambridge CB4 0WF, UK, 44-0-1223-432254; fax 44-0-1223-423623; www.rsc.org/ConferencesAndEvents/RSCConferences/FD134.

10-12 ▼ Intl. Association for Boundary Element Methods (IABEM) Conf., *Graz, Austria*. Martin Schanz, Graz University of Technology, Institute of Applied Mechanics, Technikerstr. 4, A-8010, Graz, Austria, 43-316-873-7640; fax 43-316-873-7641; e-mail iabem2006@tugraz.at; www.iabem2006.tugraz.at.

10-12 ▼ Intl. Meeting on High Performance Computing for Computational Science (VECPAR2006), *Rio de Janeiro, Brazil*. Suely Lima, IMPA/Scientific Activities Department (DAC), Estrada Dona Castorina, 110, Jardim Botânico, Rio de Janeiro, RJ, Brazil, 22460-320, 55-21-25295277; fax 55-21-25295019; e-mail dac@impa.br; vecpar.fe.up.pt/2006.

16-20 IEEE Conf. on Nanotechnology (IEEE-NANO), *Cincinnati, OH*. Clifford Lau, Institute for Defense Analyses, 4850 Mark Center Drive, Alexandria, VA, 22311; 703-933-6525; fax 703-845-6848; e-mail clau@ida.org; www.ececs.uc.edu/~mcahay/Nano2006/index2006.html.

16-20 ▼ NC-AFM2006 9th Intl. Conf. on Noncontact Atomic Force Microscopy, *Kobe, Japan*. Masayuki Abe, Osaka University, Japan, e-mail ncafm.ele.eng.osaka-u.ac.jp; ncafm.ele.eng.osaka-u.ac.jp.

16-21 ▼ Gordon Research Conf. on Inorganic Chemistry, *Newport, RI*. Bahram Moasser, GE Global Research Center, Bldg CE, Room 134, One Research Circle, Niskayuna, NY, 12309; e-mail moasser@crd.ge.com; www.grc.org/programs/2006/inorchem.htm.

16-21 ▼ Gordon Research Conf. on Plasma Processing Science, *South Hadley, MA*. Alexander Fridman, Drexel University, MEM Dept., 3141 Chestnut Street, Philadelphia, PA, 19104; e-mail fridman@drexel.edu; www.grc.org/programs/2006/plasma.htm.

16-22 World Congress on Computational Mechanics, *Los Angeles, CA*. WCCM 2006, e-mail wccm2006@seas.ucla.edu; www.wccm2006.northwestern.edu.

22-26 Annual Meeting and Exposition of the Controlled Release Society, *Vienna, Austria*. Controlled Release Society, 3650 Annapolis Lane North, Suite 107, Minneapolis, MN 55447-5434; 763-512-0909; fax 763-765-2329, e-mail meetings@controlledrelease.org; www.controlledrelease.org.

23-28 ▼ Gordon Research Conf. on Granular and Granular-Fluid Flow, *Oxford, UK*. Christine Hrenya, University of Colorado, Dept. of Chemical and Biological Engineering, UCB 424, Boulder, CO, 80309; e-mail hrenya@colorado.edu; www.grc.org/programs/2006/granular.htm.

23-28 ▼ Gordon Research Conf. on Physical Metallurgy, *Plymouth, NH*. Alex King, Purdue University, School of Materials Engineering, 501 Northwestern Avenue, West Lafayette, IN, 47907-2044; e-mail alexking@ecn.purdue.edu; www.grc.org/programs/2006/physmet.htm.

23-28 ▼ Intl. Conf. on the Physics and Chemistry of Ice, *Bremerhaven, Germany*. PCI 2006, e-mail info@pccie2006.de; www.pccie2006.de.

30-2 Fifth Intl. Conf. on Synchrotron Radiation in Materials Science, *Chicago, IL*. www.aps.anl.gov/News/Conferences/2006/SRMS/.

30-2 IEEE Intl. Symp. on Applications of Ferroelectrics, *Sunset Beach, NC*. Jon-Paul Maria, 1001 Capability Drive, Research Building One, Office 322, Raleigh, NC 27606; 919-513-2843; fax 919-515-3419; e-mail jpmaria@ncsu.edu; www.ieee-uffc.org.

30-3 ▼ Advances in Materials and Processing Technologies (AMPT), *Las Vegas, NV*. Patricia Davidson, Ohio University, Community and Professional Programs, 113 Haning Hall, Athens, OH 45701, 740-593-1767; fax 740-593-9476; e-mail davidson@ohio.edu; www.ohiou.edu/ampt.

30-3 ▼ Microscopy and Microanalysis 2006, *Chicago, IL*. Microscopy/Marketing & Education, Inc., Microscopy & Microanalysis Meeting Management, 125 Parido Street, Suite 102, Springfield, MA, 01118-2130; 972-954-8011; fax 972-954-8018; e-mail corporate@mme1.com; mm2006.microscopy.org.

30-4 ▼ Gordon Research Conf. on Biomineralization, *New London, NH*. Joanna Aizenberg, Lucent Technologies, Bell Laboratories, 700 Mountain Avenue, Room 1C-365, Murray Hill, NJ 07974-2008, e-mail jaizenberg@lucent.com; www.grc.org/programs/2006/biomin.htm.

30-4 ▼ Gordon Research Conf. on Flow and Transport in Permeable Media, *Andover, NH*. Martin Blunt, Imperial College, Dept. of Earth Science and Engineering, London SW7 2AZ, UK, e-mail m.blunt@imperial.ac.uk; www.grc.org/programs/2006/flow.htm.

30-4 ▼ Gordon Research Conf. on Thin Film and Small Scale Mechanical Behavior, *Waterville, ME*. Zhigang Suo, Harvard University, Engineering and Applied Sciences Div., 29 Oxford Street, Pierce Hall 309, Cambridge, MA, 02138; e-mail suo@deas.harvard.edu; www.grc.org/programs/2006/thinfilm.htm.

30-4 ▼ ICN&T2006 Intl. Conf. on Nanoscience and Technology, *Basel, Switzerland*. ICN&T 2006, c/o AKM Congress Service, Clarastrasse 57, CH-4005 Basel, Switzerland, 41-61-686-77-11; fax 41-61-686-77-88; e-mail info@akm.ch; www.icnt2006.ch.

31-4 Intl. Conf. on Ultrafast Phenomena, *Pacific Grove, CA*. Optical Society of America, 2010 Massachusetts Ave., NW, Washington, 202-223-8130; fax 202-223-1096; e-mail info@osa.org; www.osa.org/meetings/topicals/up.

AUGUST 2006

5-9 ▼ Symp. of The Protein Society, *San Diego, CA*. Jean Lash, FASEB/OSMC, 9650 Rockville Pike, Bethesda, MD, 20814; 301-634-7009; fax 301-634-7014; e-mail jlash@faseb.org; www.faseb.org/meetings.

6-10 IMS Annual Convention, *Chicago, IL*. ASM International Customer Service, 9639 Kinsman Road, Materials Park, OH 44073-0002; 800-336-5152 ext. 6; fax 440-338-4634; customer.service@asminternational.org; www.asminternational.com.

6-11 ▼ Gordon Research Conf. on Macromolecular Organization and Cell Function, *South Hadley, MA*. Ronald Lynch, University of Arizona, Arizona Health Sciences Center, Dept. of Physiology, Tucson, AZ, 85724; e-mail rlynch@u.arizona.edu; www.grc.org/programs/2006/macromol.htm.

6-11 ▼ Gordon Research Conf. on Science of Adhesion, *Tilton, NH*. William Unerlt, University of Maine, Physics and Astronomy Dept., Bennett Hall, Orono, ME 04469, e-mail unerlt@maine.edu; www.grc.org/programs/2006/adhesion.htm.

13-17 SPIE—Optics and Photonics, *San Diego, CA*. SPIE, P.O. Box 10, Bellingham, WA 98227-0010; 360-676-3290; fax 360-647-1445; e-mail spie@spie.org; spie.org/app/conferences.

13-18 ▼ Gordon Research Conf. on Electron Donor Acceptor Interactions, *Newport, RI*. Clifford Kubiak, University of California, San Diego, Dept. of Chemistry and Biochemistry, 9500 Gilman Dr., La Jolla, CA 92093-0358; e-mail ckubiak@ucsd.edu; www.grc.org/programs/2006/eleccon.htm.

13-18 ▼ Gordon Research Conf. on Science and Technology Policy, *Big Sky, MT*. Frederick Grinnell, UT Southwestern Medical Center, Dept. of Cell Biology 5323 Harry Hines Blvd., Dallas, TX, 75230; e-mail frederick.grinnell@utsouthwestern.edu; www.grc.org/programs/2006/policy.htm.

14-18 IEEE Intl. Symp. on Electromagnetic Compatibility (EMC 2006), *Portland, OR*. Vita Feuerstein, IEEE, 445 Hoes Lane, Piscataway, 732-562-6826; fax 732-981-1203; e-mail vita@ieee.org; www.emc2006.org.

19-23 ACS National Meeting & Exposition, *Boston, MA*. National Expositions American Chemical Society, 1155 Sixteenth Street, Washington, DC, 20036; e-mail expo@acs.org; www.chemistry.org/expositions.

19-25 World Renewable Energy Congress and Exhibition, *Florence, Italy*. Ali Sayigh, PO Box 362, Brighton BN2 1YH, United Kingdom, 44-1273-625-643; fax 44-1273-625-768; e-mail asayigh@netcomuk.co.uk; www.wreconk.co.uk/wreconk.html.

20-25 ▼ Gordon Research Conf. on Drug Carriers in Medicine and Biology, *Big Sky, MT*. Alexander Kabanov, Univ. of Nebraska Medical Center, 985830 Nebraska Medical Center, Omaha, NE 68198-5830; e-mail akabanov@unmc.edu; www.grc.org/programs/2006/drugcarr.htm.

20-25 Intl. Conf. on the Application of Accelerators in Research and Industry, *Fort Worth, TX*. Margaret Hall, University of North Texas, PO Box 311427, Denton, TX, 76203-1427; 940-565-3250; fax 940-565-2227; e-mail caari2006@unt.edu; www.caari2006.com.

20-26 Intl. Conf. on Nanostructured Materials, *Bangalore, India*. Prof. K. Chattopadhyay, Dept. of Metallurgy, Indian Institute of Science, Bangalore 560 012, India; 91-80-22932262; fax 91-80-23601991; e-mail nano2006@met.iisc.ernet.in; met.iisc.ernet.in/~nano2006.

21-24 IEEE/LEOS Intl. Conf. on Optical MEMs and Their Applications (MOEMS), *Big Sky, MT*. IEEE/LEOS, 445 Hoes Lane, PO Box 1331, Piscataway, NJ, 08855; 732-562-3899; fax 732-562-8434; e-mail leosconferences@ieee.org; www.i-leos.org.

21-25 ▼ Intl. Conf. on Biomagnetism, *Vancouver, Canada*. Secretariat Biomag 2006, c/o Venue West Conference Services Ltd., 645 - 375 Water Street, Vancouver, BC, Canada V6B 5C6; 604-681-5226; fax 604-681-2503; e-mail congress@venuewest.com; www.biomag2006.ca.

23-25 ▼ NESAC/BIO Workshop on Surface Characterization of Biomaterials, *Seattle, WA*. University of Washington, NESAC/BIO—National ESCA and Surface Analysis Center, Depts. of Bioengineering and Chemical Engineering Box 351750, Seattle, WA 98195-1750, 206-685-1229; fax 206-543-3778; e-mail info@nb.engr.washington.edu; www.nb.engr.washington.edu.

26-27 GIA Gemological Research Conf., *San Diego, CA*. GIA, 5345 Armada Drive, Carlsbad, CA 92008-4602; 760-603-4019; fax 760-603-4021; e-mail gemconference@gia.edu; www.gia.edu/newsroom/608/21821/news_release_details.cfm.

27-31 TMS—Sohn Intl. Symp. on Advanced Materials: Principles, Technologies, and Industrial Practice, *San Diego, CA*. TMS Meetings Services, 184 Thorn Hill Road, Warrendale, PA, 15086; 724-776-9000 x243; fax 724-776-3770; e-mail mtgserv@tms.org; www.tms.org/Meetings/Specialty/FallExt2006/FallExt2006-Home.html. **Endorsed.**

27-1 World Congress on Medical Physics and Biomedical Engineering (WC 2006), *Seoul, South Korea*. Secretariat WC 2006, SL Gangnam, PO Box 305, Seoul, Korea (South), 82-2-3476-7700; fax 82-2-3476-8800; e-mail wc2006@koconex.com; www.wc2006-seoul.org.

29-1 ▼ Conf. on Computational Physics (CCP 2006), *Gyeongju, South Korea*. CCP 2006, e-mail asw@physics.postech.ac.kr; ccp2006.postech.edu.

30-3 Intl. Conf. of the IEEE Engineering in Medicine and Biology Society, *New York, NY*. Jodi Strock, IEEE/EMBS, 445 Hoes Lane, Piscataway, 732-562-3451; fax 732-981-1769; e-mail j.strock@ieee.org; www.ieee.org.

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3-7 Polymer Networks Group Conf. 2006—Functional and Biological gels and networks: theory and experiment, *Sheffield, UK*. Shelagh Cowley, University of Sheffield, Dainton Building, Brook Hill, Sheffield, UK, 44-0-114-222-9537; fax 44-0-114-222-9389; e-mail s.h.cowley@sheffield.ac.uk; www.polymernetworks.group.shef.ac.uk.

3-8 ▼ Gordon Research Conf. on Bioelectrochemistry, *Aussois, France*. Justin Teissie, CNRS, Inst. of Pharma and Struct Biology, 205 Route de Narbonne, UMR 5089, Toulouse, Cedex 31077, France; e-mail justing.teissie@ipbs.fr; www.grc.org/programs/2006/bioelec.htm.

4-8 ▼ Trends in Nanotechnology (TNT2006), *Grenoble, France*. Antonio Correia, Fundacion PHANTOMS, Madrid Science Park, Pabellón C, Ctra. Colmenar Viejo Km 15, Ciudad Universitaria de Cantoblanco-UAM, 28049 Madrid, Spain; e-mail antonio@phantomsnet.net; www.tnt2006.org.

5-8 European Conf. on Computational Fluid Dynamics (ECCOMAS CFD 2006), *Egmond aan Zee, Netherlands*. Secretariat ECCOMAS CFD 2006, Delft University of Technology, Mekelweg 4, 2628 CD Delft, Delft, Netherlands, 31-0-6-27227520; fax 31-0-10-5112119; e-mail eccomas CFD2006@math.tudelft.nl; www.eccomas CFD2006.nl.

6-8 Intl. Conf. on the Characterization and Control of Interfaces (ICCCI 2006), *Kurashiki, Japan*. Makio Naito, Osaka University, 11-1, Mihogaoka, Ibaraki, Osaka, Japan, 81-6-6879-8660; fax 81-6-6879-8680; e-mail m-naito@jwri.osaka-u.ac.jp; www.jwri.osaka-u.ac.jp/%7Econf/iccci2006/index.html.

10-14 ACS National Meeting and Exposition, *San Francisco, CA*. American Chemical Society, attn: National Expositions, 1155 Sixteenth Street, Washington, DC 20036; expo@acs.org; chemistry.org/expositions.

10-14 ▼ **IUMRS Intl. Conf. in Asia (IUMRS-ICA-2006)**, Jeju, Korea. Hyeongtag Jeon, Hanyang University, Division of Materials Science and Engineering, Seongdong-gu, Seoul 133-791, Korea; 82-2-2220-0387; fax 82-2-2292-3523; e-mail ica2006@hanyang.ac.kr; www.cheric.org/~ica2006. **MRS-K, IUMRS, C-MRS, MRS-I, MRS-J, MRS-S, MRS-T.**

10-15 ESOMAT—European Symp. on Martensitic Transformations, Bochum, Germany. ESOMAT; e-mail esomat06@ruhr-uni-bochum.de; www.ruhr-uni-bochum.de/esomat06.

10-15 ▼ Gordon Research Conf. on Electronic Spectroscopy and Dynamics, Les Diablerets, Switzerland. Frederic Merkt, ETH Zuerich, Lab. Fur Physikalische Chemie, ETH Honggerberg, HCI, Zuerich CH-8093, Switzerland; e-mail merkt@xuv.phys.chem.ethz.ch; www.grc.org/programs/2006/elecspec.htm.

12-15 Intl. Conf. on Computational Structures Technology (CST 2006), Las Palmas de Gran Canaria, Spain. Dun Eaglais, Civil-Comp Limited, Station Brae, Kippen, Stirling, United Kingdom, 44-0-1786-870-166; fax 44-0-1786-870-167; e-mail info@civil-comp.com; www.civil-comp.com/conf/cst2006.htm.

12-15 Intl. Conf. on Engineering Computational Technology (ECT 2006), Las Palmas de Gran Canaria, Spain. Dun Eaglais, Civil-Comp Limited, Station Brae, Kippen, Stirling, UK; 44-0-1786-870-166; fax 44-0-1786-870-167; e-mail info@civil-comp.com; www.civil-comp.com/conf/ect2006.htm.

13-14 ▼ Intl. Conf. on Foam Processing and Technology (FOAMS 2006), Itasca, IL. Society of Plastics Engineers, 14 Fairfield Drive, P.O. Box 403, Brookfield, CT 06804-0403; 203-775-0471, fax 203-775-8490; e-mail info@4spe.org; www.4spe.org/conf/foams06/0609foams.php.

13-15 European Conf. on Residual Stresses (ECRS 7), Berlin, Germany. Walter Reimers, Technical University Berlin, Sekr BH-18, Ernst-Reuter-Platz 1, Berlin, Germany, 49-0-30-314-22417; fax 49-0-30-314-22996; e-mail Walter.Reimers@TU-Berlin.de; www.tu-berlin.de/fak3/wewi/metallische_werkstoffe/ecrs7.

13-15 ▼ Intl. Conf. on Engineering Failure Analysis, Toronto, Canada. Claire Norris, ICEFA-II Conference Secretariat 51 Kestrel Way, Wokingham, Berkshire RG41 3HA, UK; 44-0-118-377-4696; fax 44-0-118-977-6680; e-mail icefa@elsevier.com; www.icefa.elsevier.com.

16-20 ▼ Thermoforming Conf., Nashville, TN. Society of Plastics Engineers, 14 Fairfield Drive, P.O. Box 403, Brookfield, CT 06804-0403; 203-775-0471, fax 203-775-8490; e-mail info@4spe.org; www.4spe.org/conf/thermo06/0609thermo.php.

17-19 ▼ Color and Appearance Conf., Cincinnati, OH. Society of Plastics Engineers, 14 Fairfield Drive, P.O. Box 403, Brookfield, CT 06804-0403; 203-775-0471, fax 203-775-8490; e-mail info@4spe.org; www.4spe.org/conf.

17-22 ▼ Intl. Conf. on Fatigue Damage of Structural Materials, Hyannis, MA. Sophie Peters, Elsevier, The Boulevard, Langford Lane, Kidlington, Oxford, UK; 44-0-1865-843643; fax 44-0-1865-843958; e-mail s.peters@elsevier.com; www.fatiguedamage.elsevier.com.

17-22 Workshop on Non Equilibrium Phenomena in Supercooled Fluids, Glasses and Amorphous Materials, Pisa, Italy. Laura Andreozzi, Università di Pisa, Largo Pontecorvo n.3, I-56127, Pisa, Italy, 39-050-2214891; fax 39-050-2214890; e-mail workshop4@df.unipi.it; wneqp4.df.unipi.it.

18-20 ▼ Materials Science & Technology Conf., Cincinnati, OH. Customer Service ASM International, 9639 Kinsman Road, Materials Park, OH, 44073-0002; 800-336-5152 ext 6; fax 440-338-4634; e-mail Customerservice@asminternational.org; www.asmiinternational.org.

18-21 ▼ Environmental Forensics: Chemical, Physical and Biological Methods, Durham, UK. RSC Conferences, Thomas Graham House, Science Park, Milton Road, Cambridge CB4 0WF, UK; 44-0-1223-432254; fax 44-0-1223-423623; www.rsc.org/ConferencesAndEvents/RSCConferences/EnvForen.

18-22 Intl. Conf. on the Structure of Non-Crystalline Materials, Praha, Czech Republic. Romana Kocova, Icaris Conference Management, m. Dr. Holého 8, 180 00 Praha 8—Liben, Czech Republic; 420-284-823-250; fax 420-266-312-113; e-mail romana@icaris.cz; www.icaris.info/NCM10.

19-20 Silicone Elastomers 2006, Frankfurt, Germany. Rapra Technology, Shawbury, Shrewsbury, SY4 4NR, United Kingdom, 44-0-1939-250383; fax 44-0-1939-251118; e-mail conferences@rapra.net; www.rapra.net/conferences/siliconeelastomers06.

20-22 ▼ Small Times NanoCon Intl., Las Vegas, NV. Kelli Felker, Small Times Media, 655 Phoenix Drive, Ann Arbor, MI, 48108; 734-528-6263; fax 734-994-1554; e-mail kelifelker@smalltimes.com; nce06.events.pennnet.com.

24-28 Intl. Symp. on Crystallization in Glasses and Liquids, Jackson Hole, WY. The American Ceramic Society, 735 Ceramic Place, Suite 100, Westerville, OH, 43081; 614-890-4700; fax 614-899-6109; e-mail info@ceramics.org; www.ceramics.org/meetings/crystallization.

24-29 Intl. Congress on Solid State Chemistry (SSC 2006), Pardubice, Czech Republic. Tomas Wagner, University of Pardubice, Legions Sq. 565, 532 10, Pardubice, Czech Republic, 420-466-037-144; fax 420-466-037-311; e-mail ssc@upce.cz; ssc.upce.cz.

24-29 Process Intensification and Process Innovation—(PI)2 II Cleaner, Sustainable, Efficient Technologies for the Future, Christchurch, New Zealand. ECI, 6 Metro Tech Center, Brooklyn, NY, 11201; 718-260-3743; fax 718-260-3754; e-mail info@eci.poly.edu; www.engconfintl.org/gap.html.

27-28 ▼ nanoTX 06, Dallas, TX. nanoTX 06, 437 Southfork, Suite 400, Dallas/Fort Worth, TX, 75057; 214-513-9567; fax 866-815-0565; e-mail info@nanotx.biz; www.nanotx.biz.

OCTOBER 2006

1-5 Metabolic Engineering VI: From recDNA towards Engineering Biological Systems, Noordwijkerhout, Netherlands. ECI, 6 Metro Tech Center, Brooklyn, NY, 11201; 718-260-3743; fax 718-260-3754; e-mail info@eci.poly.edu; www.engconfintl.org/6ay.html.

3-6 World Congress on Emulsions, Lyon, France. 140 cours Charlemagne, 69002 Lyon, France; 33-0-4-72-77-45-50; fax 33-0-4-72-77-45-77; e-mail cme@package.fr; www.cme-emulsion.com.

4-6 Knowledge Foundation TCA Summit 2006—Innovations in Materials Science for Technology Commercialization, Washington, DC. Knowledge Foundation, 18 Webster Street, Brookline, MA, 02446-4938; (617) 232-7400; fax (617) 232-9171; e-mail custserv@knowledgefoundation.com; www.knowledgefoundation.com.

5-7 ACS Northeast Regional Meeting, Binghamton, NY. Beverly Johnson, American Chemical Society, Regional Meetings, 1155 Sixteenth Street, Washington, DC 20036; 202-872-6264; e-mail b_johnson@acs.org. **Endorsed.**

10-14 ▼ American Society of Human Genetics Annual Meeting, New Orleans, LA. Jean Lash, FASEB/OSMC, 9650 Rockville Pike, Bethesda, MD, 20814; 301-634-7009; fax 301-634-7014; e-mail jlash@faseb.org; www.faseb.org/meetings.

10-14 Biomedical Engineering Society 2006 Annual Fall Meeting, Chicago, IL. Biomedical Engineering Society, 8401 Corporate Drive, Suite 225, Landover, MD, 20785-2224; 301-459-1999; fax 301-459-2444; e-mail info@bmes.org; www.bmes.org/meetings.asp.

16-19 Material Science and Technology Conf. and Exhibition (MS&T06), Cincinnati, OH. The American Ceramic Society, 735 Ceramic Place, Suite 100, Westerville, OH, 43081; 614-890-4700; fax 614-899-6109; e-mail info@ceramics.org; www.ceramics.org/meetings.

17-18 Plastics Additives and Compounding Conf. (Addcon World 2006), Cologne, Germany. Rapra Technology, Shawbury, Shrewsbury, SY4 4NR, United Kingdom, 44-0-1939-250383; fax 44-0-1939-251118; e-mail conferences@rapra.net; www.rapra.net/conferences/addcon06.

19-20 ▼ Intl. Activated Carbon Conf., Pittsburgh, PA. Henry Nowicki, PACS Testing and Consulting, 409 Meade Drive, Coraopolis, PA, 15108; 724-457-6576; fax 724-457-1214; e-mail hnpacs@aol.com; cbrunning.net/pacs/conferences/IACC/IACC18.htm.

22-27 ▼ Gordon Research Conf. on Biointerface Science, Les Diablerets, Switzerland. Ashutosh Chilkoti, Duke University, Dept. of Biomedical Engineering, Box 90281, Durham, NC, 27708-0281; e-mail chilkoti@duke.edu; www.grc.org/programs/2006/bioint.htm.

23-24 ▼ SPE Engineering Properties and Structure Division (TopCon 2006), Akron, OH. Society of Plastics Engineers, 14 Fairfield Drive, P.O. Box 403, Brookfield, CT 06804-0403; 203-775-0471, fax 203-775-8490; e-mail info@4spe.org; www.4spe.org/conf/eps-div06/0610epsdiv.php.

29-2 XI Intl. Conf. on the Physics of Non-Crystalline Solids, Rhodes, Greece. Vasso Zatta, Institute of Materials Science, NCSR "Demokritos" 1530 10 Aghia Paraskevi Attiki, Greece; 30-210-6503381; fax 30-210-6503323; e-mail vzatta@ims.demokritos.gr; web.ims.demokritos.gr/glass/XI-PNCS.

29-2 Control of Particulate Processes, Harrison Hot Springs, BC. ECI, 6 Metro Tech Center, Brooklyn, NY, 11201; 718-260-3743; fax 718-260-3754; e-mail info@eci.poly.edu; www.engconfintl.org/6av.html.

30-3 ▼ APS Annual DPP Meeting, Philadelphia, PA. APS, www.aps.org/meet/calendar.cfm.

NOVEMBER 2006

8-9 Thermoplastic Elastomers Conf. (TPE 2006), Munich, Germany. Rapra Technology, Shawbury, Shrewsbury, SY4 4NR, UK; 44-0-1939-250383; fax 44-0-1939-251118; e-mail conferences@rapra.net; www.rapra.net/conferences/tpe06.

12-16 ISTFA Conf. and Exposition, Austin, TX. ASM International Customer Service, 9639 Kinsman Road, Materials Park, OH 44073-0002; 800-336-5152 ext. 6; fax 440-338-4634; e-mail customer.service@asminternational.org; www.asmiinternational.com

13-17 Fuel Cell Seminar 2006, Honolulu, HI. Fuel Cell Seminar Headquarters, c/o Courtesy Associates, 2025 M Street, Suite 800, Washington, DC, 20036; 202-973-8671; fax 202-331-0111; e-mail fuelcell@courtesyassoc.com; www.fuelcellseminar.com.

27-1 2006 MRS Fall Meeting, Boston, MA. Materials Research Society, 506 Keystone Drive, Warrendale, PA 15086; 724-779-3003; fax 724-779-8313; e-mail info@mrs.org; www.mrs.org. **MRS.**

DECEMBER 2006

4-5 Intl. Conf. Nanoinprint Lithography Application in Nanosystems and Nanodevices (NanoKAP 2006), Miami Beach, FL. Knowledge Foundation, 18 Webster Street, Brookline, MA, 02446-4938; (617) 232-7400; fax (617) 232-9171; e-mail custserv@knowledgefoundation.com; www.knowledgefoundation.com.

5-6 Lithium Mobile Power 2006 - Conf. on Advances in Lithium Battery Technologies for Mobile Applications, *Miami Beach, FL*. Knowledge Foundation, 18 Webster Street, Brookline, MA, 02446-4938; (617) 232-7400; fax (617) 232-9171; e-mail custserv@knowledgefoundation.com; www.knowledgefoundation.com.

5-6 RubberChem 2006, *Munich, Germany*. Rapra Technology, 44-0-1939-250383; e-mail conferences@rapra.net; www.rapra.net/conferences/rubberchem06.

14-16 ▼ Flexible Packaging Conf. (FlexPackCon 2006), *Orlando, FL*. Society of Plastics Engineers, 14 Fairfield Drive, P.O. Box 403, Brookfield, CT 06804-0403; 203-775-0471, fax 203-775-8490; e-mail info@4spe.org; www.4spe.org/conf/flexpack06.

FEBRUARY 2007

20-23 Intl. Conf. on Recent Advances in Composite Materials (ICRACM), *New Delhi, India*. V.K. Srivastava, ICRACM-2007, Dept. of Mechanical Engineering, Institute of Technology, Banaras Hindu University, Varanasi-221005, India; 91-542-2368157; e-mail vijays_sa@yahoo.com; www.htu.ac.in/notification/icracm.htm.

25-1 2007 TMS Annual Meeting and Exhibition, *Orlando, FL*. TMS Meetings Services, 184 Thorn Hill Road, Warrendale, PA, 15086; 724-776-9000 x243; fax 724-776-3770; e-mail mtgserv@tms.org; www.tms.org/meetings/meetings.asp.

MARCH 2007

3-7 Biophysical Society Annual Meeting, *Baltimore, MD*. www.biophysical.org/meetings/future.htm.

5-9 ▼ APS March Meeting 2007, *Denver, CO*. APS, www.aps.org/meet/calendar.cfm.

19-22 Intl. Laser Safety Conf. (ILSC), *San Francisco, CA*. Laser Institute of America, 13501 Ingenuity Drive, Suite 128, Orlando, FL, 32826; 407-380-1553; fax 407-380-5588; e-mail bcohen@laserinstitute.org; www.laserinstitute.org/conferences/ilsc.

25-29 ACS National Meeting & Exposition, *Chicago, IL*. American Chemical Society, attn: National Expositions, 1155 Sixteenth Street, Washington, DC 20036; e-mail expo@acs.org; chemistry.org/expositions.

APRIL 2007

9-13 2007 MRS Spring Meeting, *San Francisco, CA*. Materials Research Society, 506 Keystone Drive, Warrendale; 724-779-3003; fax 724-779-8313; e-mail info@mrs.org; www.mrs.org. **MRS**.

14-17 ▼ APS April Meeting 2007, *Jacksonville, FL*. APS, www.aps.org/meet/calendar.cfm.

28-2 ▼ Experimental Biology 2007 Annual Meeting, *Washington, DC*. Jean Lash, FASEB/OSMC, 9650 Rockville Pike, Bethesda, MD, 20814; 301-634-7009; fax 301-634-7014; e-mail jlash@faseb.org; www.faseb.org/meetings.

MAY 2007

13-17 ▼ MPIF Intl. Conf. on Powder Metallurgy and Particulate Materials (PowderMet 2007), *Denver, CO*. MPIF, 105 College Road East, Princeton, NJ, 08540; 609-452-7700; fax 609-987-8523; e-mail info@mpif.org; www.mpiif.org.

27-31 ▼ 10th Intl. Conf. on the Mechanical Behavior of Materials, *Seoul, Korea*. JC International, Twin Tower B #1008, 275-4 Yangjae-dong, Seocho-gu, 137-130 Seoul, Korea, 82-2-571-2724; fax 82-2-571-2721; e-mail jpcark@jcenter.co.kr; icm10.org.

JUNE 2007

5-9 ▼ APS Annual Division of Atomic, Molecular and Optical Physics Meeting, *Calgary, AB*. APS, www.aps.org/meet/calendar.cfm.

25-28 ECM VIII: Bone Tissue Engineering, *Davos, Switzerland*. Sonia Wahl, AO Research Institute, Clavadelerstrasse, CH-7270 Davos Platz, Davos, Switzerland, 41-81-41-42-541; fax 41-81-41-42-299; e-mail sonia.wahl@aofoundation.org; www.ecmjournal.org/ecm_meetings/next_event.shtml.

JULY 2007

2-6 Intl. Congress on Glass, *Strasbourg, France*. ICG 2007, CRIT Materiaux Alsace, 19 rue de Saint Junien, BP 23, F67305 Schiltigheim Cedex, France; 33-0-3-88-19-15-10; fax 33-0-3-88-19-15-14; e-mail info@icg2007.org; www.icg2007.org.

AUGUST 2007

6-9 Microscopy and Micro-analysis 2007, *Ft. Lauderdale, FL*. Microscopy/Marketing & Education, Inc., Meeting Management Microscopy & Microanalysis, 125 Parido Street, Suite 102, Springfield, MA, 01118-2130; 972-954-8011; fax 972-954-8018; e-mail corporate@mme1.com; microscopy.org/MMMeetings.

19-23 ACS National Meeting and Exposition, *Boston, MA*. American Chemical Society, ATTN: National Expositions, 1155 Sixteenth Street, Washington, DC 20036; e-mail expo@acs.org; chemistry.org/expositions.

OCTOBER 2007

8-13 Intl. Conf. on Advanced Materials (IUMRS-ICAM 2007), *Bangalore, India*. Secretariat IUMRS-ICAM-2007, Materials Research Society of India, Bangalore, India, 91-080-22932882; fax 91-080-23602028; e-mail secretariat@icam2007.com; www.icam2007.com. **IUMRS/MRS-I**.

NOVEMBER 2007

12-16 ▼ APS Annual DPP Meeting, *Orlando, FL*. APS, www.aps.org/meet/calendar.cfm.

26-30 2007 MRS Fall Meeting, *Boston, MA*. Materials Research Society, 506 Keystone Drive, Warrendale, 724-779-3003; fax 724-779-8313; e-mail info@mrs.org; <http://www.mrs.org>. **MRS**.

MARCH 2008

10-14 ▼ APS March Meeting 2008, *New Orleans, LA*. APS, www.aps.org/meet/calendar.cfm.

24-28 2008 MRS Spring Meeting, *San Francisco, CA*. Materials Research Society, 506 Keystone Drive, Warrendale, 724-779-3003; fax 724-779-8313; e-mail info@mrs.org; www.mrs.org. **MRS**.

APRIL 2008

3-9 Experimental Biology 2008 Annual Meeting, *San Diego, CA*. Jean Lash, FASEB/OSMC, 9650 Rockville Pike, Bethesda, MD, 20814; 301-634-7009; fax 301-634-7014; e-mail jlash@faseb.org; www.faseb.org/meetings.

12-15 ▼ APS April Meeting 2008, *St. Louis, MO*. APS, www.aps.org/meet/calendar.cfm.

MAY 2008

28-1 World Biomaterials Congress, *Amsterdam, Netherlands*. Secretariat World Biomaterials Congress, International Conference Services, P.O. Box 83005, 1080 AA, Amsterdam, Netherlands, 31-0-206793218; fax 31-0-206758236; e-mail info.wbc2008@ics-online.nl; www.wbc2008.com.

JUNE 2008

23-26 ECM IX Fifty Years of AO: Internal Fixation: From Research to the Clinics, *Davos, Switzerland*. Sonia Wahl, AO Research Institute, Clavadelerstrasse, CH-7270 Davos Platz, Davos, Switzerland, 41-81-41-42-541; fax 41-81-41-42-299; e-mail sonia.wahl@aofoundation.org; www.ecmjournal.org/ecm_meetings/next_event.shtml.

NOVEMBER 2008

17-21 ▼ APS Annual DPP Meeting, *Dallas, TX*. APS, www.aps.org/meet/calendar.cfm.

23-26 ECM IX Fifty Years of AO: Internal Fixation: From Research to the Clinics, *Davos, Switzerland*. Sonia Wahl, AO Research Institute, Clavadelerstrasse, CH-7270 Davos Platz, Davos, Switzerland, 41-81-41-42-541; fax 41-81-41-42-299; e-mail sonia.wahl@aofoundation.org; www.ecmjournal.org/ecm_meetings/next_event.shtml.

DECEMBER 2008

1-5 2008 MRS Fall Meeting, *Boston, MA*. Materials Research Society, 506 Keystone Drive, Warrendale, 724-779-3003; fax 724-779-8313; e-mail info@mrs.org; www.mrs.org. **MRS**. □



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Location & Hours

Moscone West • Exhibit Hall (Level 1)

Monday, April 17 (Registration only).....	1:00 pm – 5:00 pm
Tuesday, April 18	11:00 am – 6:00 pm
Wednesday, April 19	11:00 am – 6:00 pm
Thursday, April 20	10:00 am – 1:00 pm